



WW12R, WW08R, WW06R

±1%, ±5%

Metal Low Ohm Power Chip Resistors Size 1206 (1W), 0805 (0.5W), 0603 (0.33W) RoHS Exemption free and Lead free Sensing Type

*Contents in this sheet are subject to change without prior notice.

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FEATURE

- 1. Metal ultra low and stable TCR performance
- 2. High power rating and compact size
- 3. High reliability and stability
- 4. Reduced size of final equipment
- 5. RoHS exemption free & Halogen free & Lead free
- 6. Inductance below 1nH

APPLICATION

- Power supply
- PDA
- Digital meter
- Computer
- Automotives
- Battery charger
- DC-DC power converter

DESCRIPTION

The resistors are constructed in a high grade low resistive metal body. The resistive layer is covered with a protective coat and printed a resistance marking code over it. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Lead free terminations.



Fig 1. Construction of Chip-R

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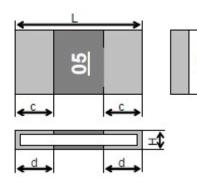
QUICK REFERENCE DATA

Item		General Specification			
Series No.	WW06R	WW08R	WW12R		
Size code	0603 (1608)	0805(2012)	1206 (3216)		
Resistance Tolerance		±5% , ±1%			
Resistance Range	5, 10mΩ	2, 4, 5, 6, 8, 9 10mΩ,	1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 12, 13, 14, 15 mΩ		
TCR (ppm/°C)		±70 ppm/°C			
Max. power at T _{amb} =70°C	1/3 W	1/2 W	1W		
Max. Operation Current (DC or RMS)	8.1A, 5.7A	7A ~ 15.8A	31.6A ~ 8.2A		
Operation temperature	-55 ~ +155'C				

Note : Max. Operation Current : So called RCWC (Rated Continuous Working Current) is determined by

 $RCWC = \sqrt{Rated Power / Resistance Value}$ listed above.

MECHANICAL DATA





Unit: mm

Туре	Size (inch)	Resistance	L (mm)	W (mm)	H (mm)	c (mm)	d (mm)				
	0000	5mΩ	4 6010 40					0.0010.40	0.33±0.10	0.20±0.10	0.50±0.10
WW06R	0603	10mΩ	1.60±0.10	0.80±0.10	0.30±0.10	0.20±0.10	0.30±0.10				
		2mΩ		0.22±0.10	0.33±0.10	0.55±0.20					
		4mΩ					0.35±0.10	0.33±0.10	0.70±0.20		
		5mΩ		5 1.25±0.15	0.35±0.10	0.33±0.10	0.60±0.20				
WW08R	8R 0805	6mΩ			0.35±0.10	0.33±0.10	0.47±0.20				
		8mΩ			0.22±0.10	0.33±0.10	0.60±0.20				
		9mΩ			0.22±0.10	0.33±0.10	0.52±0.20				
		10mΩ			0.22±0.10	0.33±0.10	0.47±0.20				
WW12R	1206	1mΩ	3.2±0.15	1.60±0.15	0.32±0.10	1.10±0.25					

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2mΩ]		0.32±0.10	0.50	±0.25
3mΩ			0.35±0.10	0.70±0.25	1.30±0.25
4mΩ			0.35±0.10	1.10	±0.25
5mΩ			0.35±0.10	1.00	±0.25
6mΩ			0.35±0.1	0.80	±0.25
7mΩ			0.35±0.1	0.70	±0.25
8mΩ			0.35±0.1	0.50	±0.25
9mΩ			0.28±0.1	0.55	±0.25
10mΩ			0.28±0.1	0.50	±0.25
12mΩ			0.22±0.1	0.70	±0.25
13mΩ			0.22±0.1	0.60	±0.25
14mΩ	1 to	150	0.22±0.1	0.55	±0.25
15mΩ	權所有		0.22±0.1	0.50	±0.25

MARKING

WW12R/WW08R each resistor is marked with a 2-digit code with underline on the protective coating to designate the nominal resistance value. WW06R has no marking!

Example:

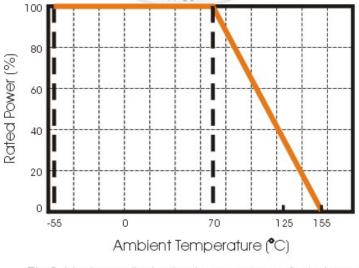
$$\frac{05}{10} = 0.005\Omega$$

 $\frac{10}{10} = 0.010\Omega$

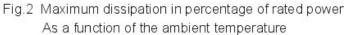
FUNCTIONAL DESCRIPTION

Derating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.2



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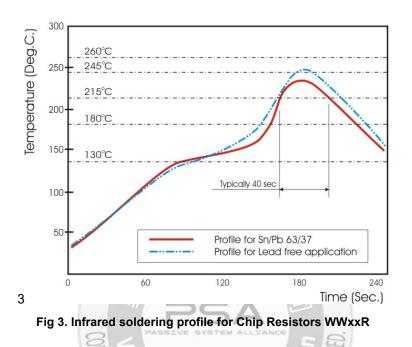




SOLDERING CONDITIONS

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 245°C during 3 seconds within lead-free solder bath. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig



CATALOGUE NUMBERS

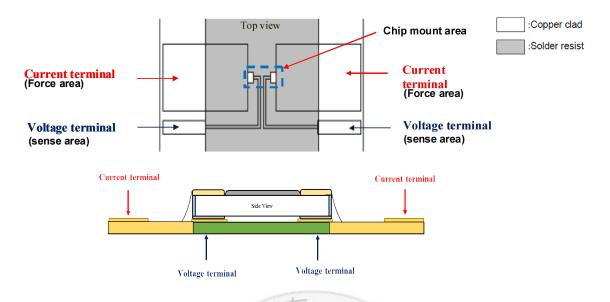
The resistors have a catalogue number starting with .

WW06 R		R005	J	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code
WW06 : 0603	R : 1/3W, 0603	R is first digit followed by 3	J :±5%	T : 7" reel	L = Sn base
WW08 : 0805	1/2W, 0805	significant digits.	F :±1%	Q : 10" reel	(lead free)
WW12 :1206	1W, 1206	$0.010\Omega = R010$			
		0.005Ω = R005			

Reeled tape packaging : 8mm width paper taping 5,000pcs per 7" reel. 10,000pcs per 10" reel.

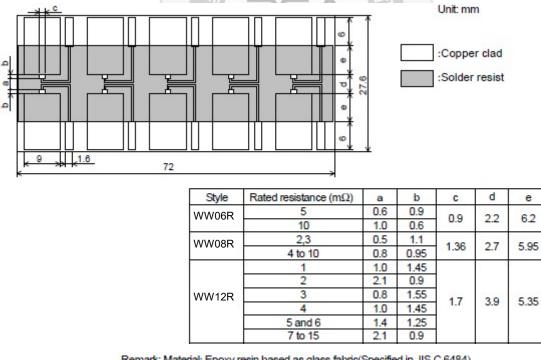


RESISTANCE MEASUREMENT SCHEMATIC DIAGRAM



The resistance measured is based on mounted on PCB to match with customer field application.

RECOMMENDED PCB LAND PATTERN



Remark: Material: Epoxy resin based as glass fabric(Specified in JIS C 6484). Thickness: 1.6mm Thickness of copper clad: 0.035mm



TEST & REQUIREMENTS

Table-4(1)

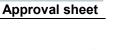
	Table- 4(1)							
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements					
1	Visual examination	Sub-clause 4.4.1	As in 4.4.1					
		Checked by visual examination.	The marking shall be legible, as checked by visual examination.					
2	Dimension	Sub-clause 4.4.2	As specified in Table-3 of this					
	Resistance	Resistance value shall be measured by mounting	specification. As in 4.5.2					
	rtealatance	the substrate of the following condition.	The resistance value shall					
		the substrate of the following conductin.	correspond with the rated resistance					
		Current	taking into account the specified					
		terminal	tolerance.					
		Copper clad						
		Voltage terminal :Solder resist						
		a: 2.9mm (2m Ω , 3m Ω , 4m Ω),						
		1.8mm (5m Ω)						
		Thickness of copper clad: 0.035mm						
		4-Terminal method						
		Measurement current: 1(A) Note:The measuring apparatus corresponding to						
		DC Low-ohm Mater (1A) of AX-1152D for ADEX						
		CORPORATION.						
3	Voltage proof	Sub-clause 4.7						
		Method: 4.6.1.4(See Figure–5)	No breakdown or flash over					
		Test voltage: Alternating voltage with a peak value						
		of 1.42 times the insulation voltage.						
		Duration: 60 s±5 s						
		Insulation resistance	R≥1GΩ					
		Test voltage: Insulation voltage Duration: 1 min.	R2100					
4	Solderability	Sub-clause 4.17	As in 4.17.4.5					
10.00	Condorcibility	Without aging	The terminations shall be covered					
		Flux: The resistors shall be immersed in a						
		non-activated soldering flux for 2 s.	coating.					
		Bath temperature: 235 °C±5 °C						
s	/	Immersion time: 2 s±0.5 s						
5	Mounting	Sub-clause 4.31						
		Substrate material: Epoxide woven glass						
	Overload	Test substrate: Figure-3						
	(in the mounted state)	Sub-clause 4.13 The applied voltage shall be 2.5 times the rated						
	(in the meaned eater)	voltage or the current corresponding to.						
		Duration: 2 s						
		Visual examination	No visible damage					
		Resistance	$\Delta R \leq \pm 1\%$					
	Solvent resistance of the	Sub–clause 4.30	Legible marking					
	marking	Solvent: 2–propanol	2002					
		Solvent temperature: 23 °C±5 °C						
		Method 1						
		Rubbing material: cotton wool						
	1	Without recovery						

Table-4(2)					
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements		
6	Mounting	Sub-clause 4.31			
		Substrate material: Epoxide woven glass			
		Test substrate: Figure-4			
	Bound strength of the end	Sub-clause 4.33			
	face plating	Bent value: 1 mm			
	1004 10	Resistance	∆R≤±1%		
	Final measurements	Sub-clause 4.33.6			
		Visual examination	No visible damage		
7	Resistance to soldering heat	Sub-clause 4.18			
		Solder temperature: 260 °C±5 °C			
		Immersion time: 10 s±0.5 s			
		Visual examination	As in 4.18.3.4		
			No sign of damage such as cracks.		
		Resistance	∆R≤±1%		
	Component solvent	Sub-clause 4.29			
	resistance	Solvent: 2-propanol			
		Solvent temperature: 23 °C±5 °C			
		Method 2			
		Recovery: 48 h			
		Visual examination	No visible damage		
		Resistance	∆R≤±1%		
8	Mounting	Sub-clause 4.31			
	201	Substrate material: Epoxide woven glass			
		Test substrate: Figure-3			
	Adhesion	Sub-clause 4.32			
		Force: 5 N			
		Duration: 10 s±1 s			
		Visual examination	No visible damage		
	Rapid change temperature	Sub–clause 4.19			
		Lower category temperature:-55 °C			
		Upper category temperature:+155 °C			
		Duration of exposure at each temperature: 30			
		min.			
		Number of cycles: 5 cycles.			
		Visual examination	No visible damage		
		Resistance	∆R≤±1%		

Table-4(2)

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No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence	Sub-clause 4.23	•
	-Dry heat	Sub-clause 4.23.2	
		Test temperature: +155 °C	
		Duration: 16 h	
	–Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C	
	- cash condition - relative.	[Severity(2)]	
	-Cold	Sub-clause 4.23.4	
	- 22-9-2-51 (147) Pi	Test temperature –55 °C	
		Duration: 2h	
	–Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
		[Severity (2)]	
	5757.757779 65	Number of cycles: 5 cycles	
	–D.C. load	Sub–clause 4.23.7	
		The applied current shall be the rated current.	
		Duration: 1 min.	
		Visual examination	No visible damage
		Resistance	∆R≤±(1%+0.0005ohm)
10	Mounting	Sub-clause 4.31	
	5	Substrate material: Epoxide woven glass	
		Test substrate: Figure-3	
		3	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C±2 °C	
		Duration: 1000 h	
		The current shall be applied in cycles of 1.5 h	
		on and 0.5 h.	
		The applied current shall be the rated current	
		Examination at 48 h, 500 h and	
		1000 h:	
		Visual examination	M. Children
		Resistance	No visible damage
			∆R≤(1%+0.0005ohm)

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	Table–4(4)							
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements					
11	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3						
	Variation of resistance with temperature	Sub–clause 4.8 +20 °C / +155 °C	As in Table–1					
12	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3						
	Damp heat, steady state	Sub–clause 4.24 Ambient temperature: 40 °C±2 °C Relative humidity: 93 $\frac{1}{3}$ % Without current applied. Visual examination Resistance	No visible damage Legible marking $\Delta R \leq t (1\%+0.0005ohm)$					
13	Dimensions (detail)	Sub-clause 4.4.3	As in Table–4					
	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3						
	Endurance at upper category temperature	Sub–clause 4.25.3 Ambient temperature: 155 °C±2 °C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	No visible damage ∆ R ≤ ±(1%+0.0005ohm)					



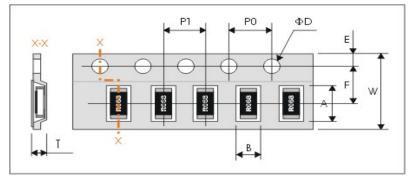
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PACKAGING

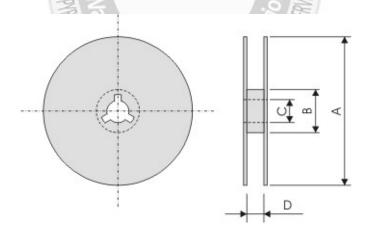
Paper Tape specifications (unit :mm)



Symbol	A	В	w	F	E	
WW06R	1.90±0.20	1.15±0.15				
WW08R	2.50±0.20	1.65±0.15	8.00±0.20	3.50±0.05	1.75±0.10	
WW12R	3.60±0.20	2.00±0.15				
	•	1.+		•	•	

		~ 所有	12		
Symbol	P1	P0	ΦD	т	
WW06R				0.8 max.	
WW08R	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	1.0 max.	
WW12R				1.0 max.	

Reel dimensions



Symbol	А	В	С	D
7"	Ф180.0 -1.5	Φ60.0±1.0	13.0±0.2	9.0 +1.0
10"	Φ254.0 ±2.0	Φ100.0±1.0	13.0±0.2	9.0 +1.0

Taping quantity

- Chip resistors 5,000 pcs per 7" reel; 10,000pcs per 10" reel.

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Walsin:

WW12RR005FTL WW12RR001FTL WW06R_FTL WW06R_JTL WW08R_FTL WW12R_FTL WW12R_JTL